Philips Semiconductors

Triacs

Product specification

BT137B series

GENERAL DESCRIPTION

Glass passivated triacs in a plastic envelope suitable for surface mounting, intended for use in applications requiring high bidirectional transient and blocking voltage capability and high thermal cycling performance. Typical applications include motor control, industrial and domestic lighting, heating and static switching.

DESCRIPTION

PINNING - SOT404

main terminal 1

main terminal 2

main terminal 2

PIN

1

2

3

mb

QUICK REFERENCE DATA

	SYMBOL	PARAMETER	MAX.	MAX.	MAX.	UNIT
	170	BT137B- BT137B- BT137B- BT137B-	500 500F 500G	600 600F 600G	800 800F 800G	
	V _{DRM}	Repetitive peak off-state	500	600	800	V
07	I _{T(RMS)} I _{TSM}	voltages RMS on-state current Non-repetitive peak on-state current	8 65	8 65	8 65	A A

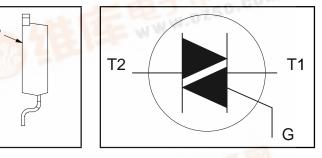
PIN CONFIGURATION

2

3

1

SYMBOL



LIMITING VALUES

gate

Limiting values in accordance with the Absolute Maximum System (IEC 134).

WWW.DZS

SYMBOL	PARAMETER	CONDITIONS	MIN.	WW	MAX.		UNIT
V _{DRM}	Repetitive peak off-state voltages		-	-500 500 ¹	-600 600 ¹	-800 800	V
I _{T(RMS)} I _{TSM}	RMS on-state current Non-repetitive peak on-state current	full sine wave; $T_{mb} \le 102$ °C full sine wave; $T_j = 25$ °C prior to surge	-		8		A
6.92	L LT. I.	t = 20 ms t = 16.7 ms	-		65 71		A
l²t dl _⊤ /dt	I ² t for fusing Repetitive rate of rise of on-state current after	t = 10 ms t = 10 ms $I_{TM} = 12 \text{ A}; I_G = 0.2 \text{ A};$ $dI_G/dt = 0.2 \text{ A}/\mu \text{s}$	-	Ha-	21		A A ² s
	triggering	T2+ G+ T2+ G- T2- G- T2- G-	15	WW	50 50 50		A/μs A/μs A/μs
I _{GM} V _{GM} P _{GM}	Peak gate current Peak gate voltage Peak gate power	T2- G+			10 2 5 5		A/μs A V W
P _{G(AV)} T _{stg} T _j	Average gate power Storage temperature Operating junction temperature	over any 20 ms period	- -40 -		0.5 150 125		°C ℃ ℃

1 Although not recommended, off-state voltages up to 800V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 6 $A/\mu s$.

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THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R _{th j-mb} R _{th j-a}	Thermal resistance junction to mounting base Thermal resistance junction to ambient	full cycle half cycle minimum footprint, FR4 board	- -	- - 55	2.0 2.4 -	K/W K/W K/W

STATIC CHARACTERISTICS

 $T_i = 25$ °C unless otherwise stated

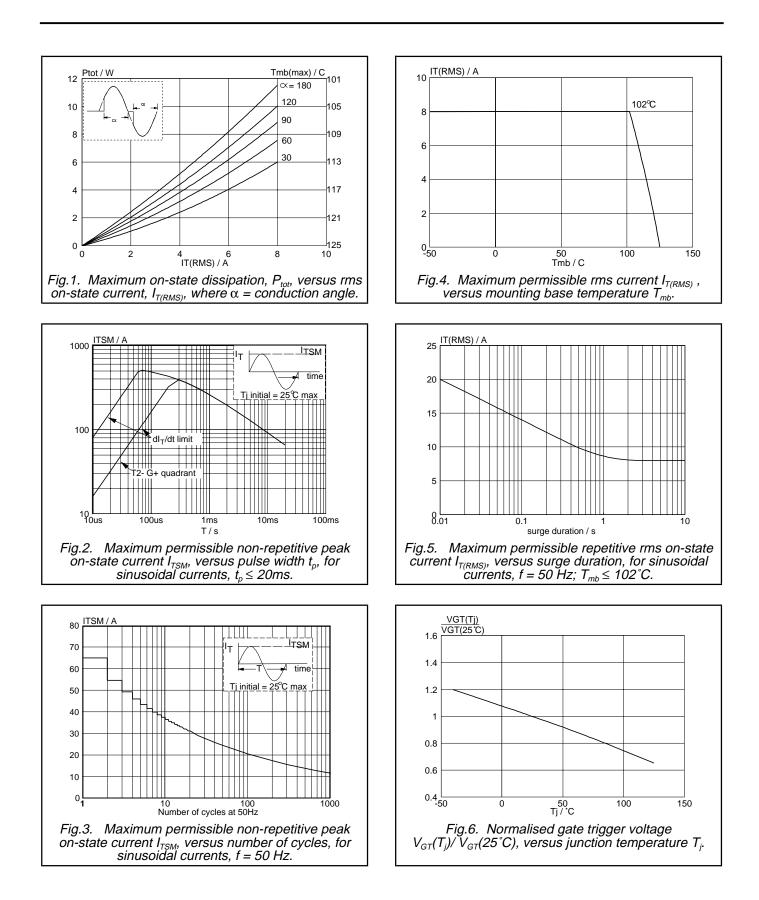
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.		MAX.		UNIT
I _{GT}	Gate trigger current	BT137B- V _D = 12 V; I _T = 0.1 A				F	G	
		T2+ G+ T2+ G-	-	5 8	35 35	25 25	50 50	mA mA
		T2- G- T2- G+	-	11 30	35 70	25 70	50 100	mA mA
	Latching current	$V_{D} = 12 \text{ V}; \text{ I}_{GT} = 0.1 \text{ A}$ T2+ G+ T2+ G- T2- G- T2- G+		7 16 5 7	30 45 30 45	30 45 30 45	45 60 45 60	mA mA mA mA
I _H	Holding current	$V_{\rm D} = 12 \text{ V}; \text{ I}_{\rm GT} = 0.1 \text{ A}$	-	5	20	20	40	mA
V _T V _{GT}	On-state voltage Gate trigger voltage	$I_{T} = 10 \text{ A}$ $V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}$ $V_{D} = 400 \text{ V}; I_{T} = 0.1 \text{ A};$	- - 0.25	1.3 0.7 0.4		1.65 1.5 -		V V V
I _D	Off-state leakage current	$T_{j}^{-} = 125 \ ^{\circ}C$ $V_{D} = V_{DRM(max)};$ $T_{j} = 125 \ ^{\circ}C$	-	0.1		0.5		mA

DYNAMIC CHARACTERISTICS

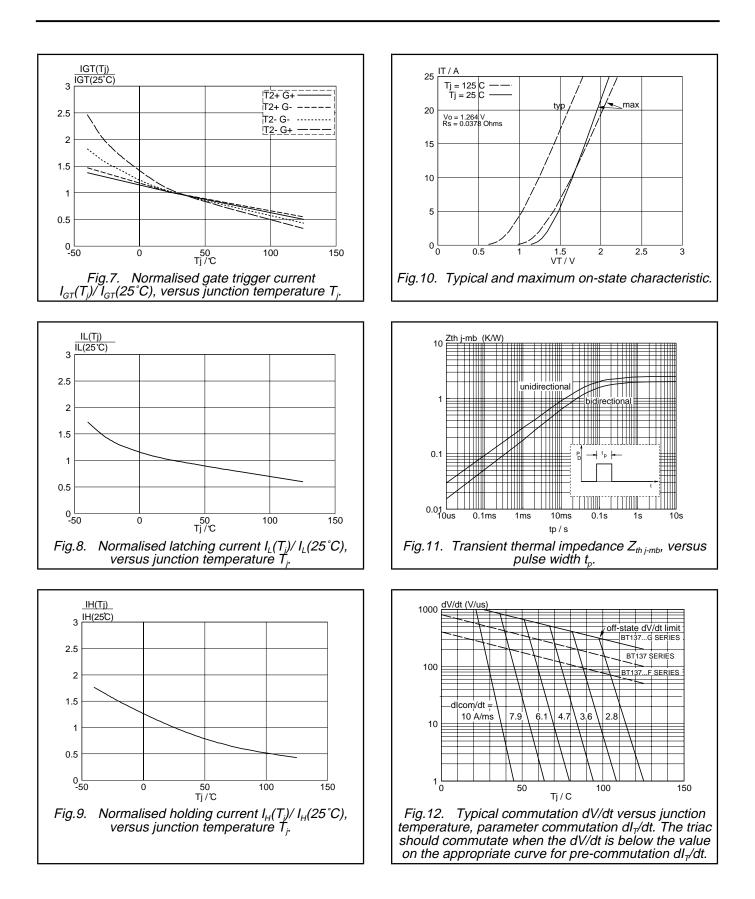
 $T_i = 25$ °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS		MIN.		TYP.	MAX.	UNIT
dV _D /dt	Critical rate of rise of off-state voltage	BT137B- $V_{DM} = 67\% V_{DRM(max)};$ $T_i = 125 °C; exponential$	 100	F 50	G 200	250	-	V/µs
dV _{com} /dt	Critical rate of change of commutating voltage	waveform; gate open circuit $V_{DM} = 400 \text{ V}; \text{ T}_{j} = 95 ^{\circ}\text{C};$ $I_{T(RMS)} = 8 \text{ A};$ $dI_{com}/dt = 3.6 \text{ A/ms}; gate$	-	-	10	20	-	V/µs
t _{gt}	Gate controlled turn-on time	open circuit $I_{TM} = 12 \text{ A}; \text{ V}_{D} = \text{V}_{DRM(max)};$ $I_{G} = 0.1 \text{ A}; \text{ dI}_{G}/\text{dt} = 5 \text{ A}/\mu\text{s}$	-	-	-	2	-	μs

BT137B series

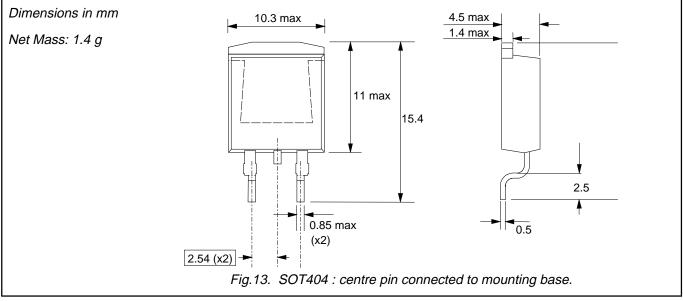


BT137B series



BT137B series

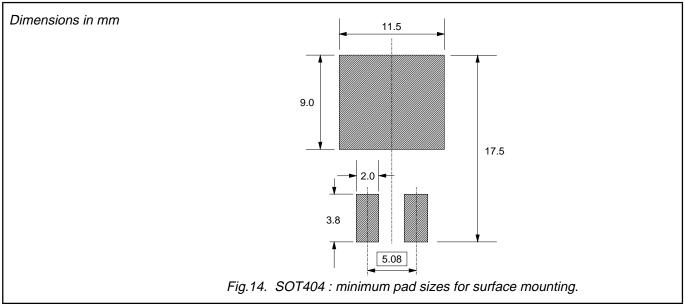
MECHANICAL DATA



Notes

1. Epoxy meets UL94 V0 at 1/8".

MOUNTING INSTRUCTIONS



Notes

1. Plastic meets UL94 V0 at 1/8".

BT137B series

DEFINITIONS

Data sheet status						
Objective specification	This data sheet contains target or goal specifications for product development.					
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.					
Product specification	This data sheet contains final product specifications.					

Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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